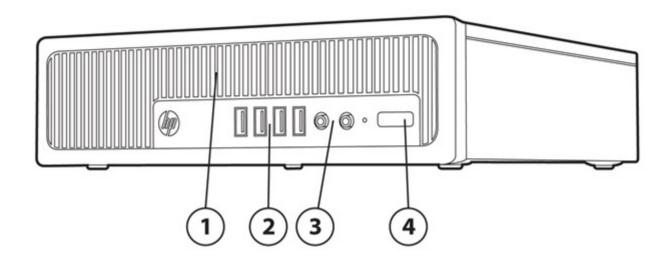
Overview

HP EliteDesk 800 G1 Ultra-slim Desktop Business PC



- 1. Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 2. (2) USB 3.0 ports, (2) USB 2.0 ports
- 3. 3.5mm headphone output and microphone jacks
- 4. Power button and PC status LED

Not Shown

Slots (1) internal mSATA connector

(1) internal PCI Express mini-card connector

(1) MXM graphics connector

Bays (1) 2.5" internal storage drive bay

Rear I/O (2) USB 3.0 ports; (4) USB 2.0 ports

(1) VGA video port; (2) DisplayPort with multi-stream video ports

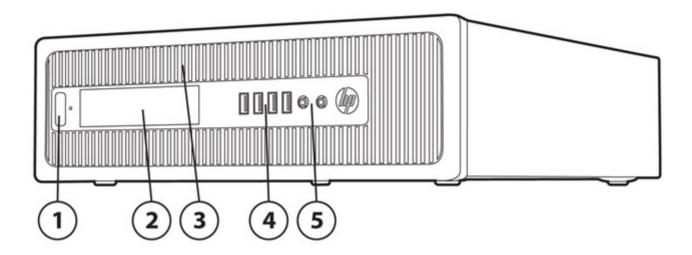
(1) RJ-45 network connector 3.5mm audio in/out jacks PS/2 keyboard and mouse ports

VESA Support for VESA 100 mounting system on top and bottom of PC chassis



Overview

HP EliteDesk 800 G1 Small Form Factor Business PC



- 1. Power button and PC status LED
- 2. 3.5" external drive bay; used for installing a Media Card Reader or 2nd data storage drive
- 3. Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 4. (2) USB 3.0 ports, (2) USB 2.0 ports
- 5. 3.5mm headphone output and microphone jack

Not Shown

Slots (2) PCI Express x16 graphics connectors; one wired as a x4

(2) PCI Express x1 accessory connectors

Bays (1) 2.5" internal storage drive bay

(1) 3.5" internal storage drive bay\

Rear I/O (2) USB 3.0 ports; (4) USB 2.0 ports

(1) VGA video port; (2) DisplayPort with multi-stream video ports

(1) RJ-45 network connector

(1) RS-232 serial port

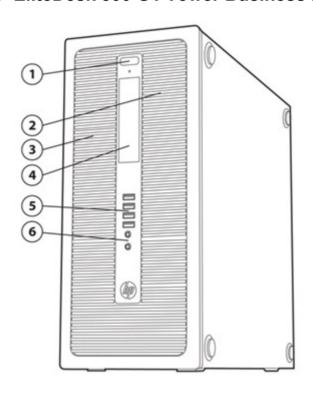
3.5mm audio in/out jacks

PS/2 keyboard and mouse ports



Overview

HP EliteDesk 800 G1 Tower Business PC



- 1. Power button and PC status LED
- 2. Slim drive bay supporting an optical disk drive (located behind removable bezel)
- 3. 5.25" half height external drive bay (located behind removable bezel)
- 4. 3.5" external drive bay; used for installing a Media Card Reader
- 5. (2) USB 3.0 ports, (2) USB 2.0 ports
- 6. 3.5mm headphone output and microphone jack

Not Shown

Slots (2) PCI Express x16 graphics connectors; one wired as a x4

(2) PCI Express x1 accessory connectors

(1) PCI accessory connector (optional)

Bays (1) 2.5" internal storage drive bay

(2) 3.5" internal storage drive bays

Rear I/O (2) USB 3.0 ports; (4) USB 2.0 ports

(1) VGA video port; (2) DisplayPort with multi-stream video ports

(1) RJ-45 network connector

(1) RS-232 serial port

3.5mm audio in/out jacks

PS/2 keyboard and mouse ports



Overview

At A Glance

- Choice of three chassis form factors: Ultra-slim Desktop, Small Form Factor and Tower
- PC chassis and all internal components and modules are manufactured with low halogen content
- HP developed and engineered UEFI BIOS supporting security, manageability and software image stability
- Intel® Q87 chipset supporting Intel 4th generation Core processors, featuring integrated Intel HD Graphics and Intel® vProTM Technology (available with select processors)
- Intel® Ethernet Connection I217L GbE LOM integrated network connection
- DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Multi-independent monitor support via VGA and dual digital DisplayPort video interfaces with multi-stream
- Discrete graphics options available for all platforms, including the USDT
- DTS Sound audio management software
- Standard and high efficiency energy saving power supply options
- ENERGY STAR qualified models certified EPEAT Gold
- SFF and TWR models can be configured with multiple data drives in a RAID array
- Optional Intel Smart Response Technology disk cache modules
- Guaranteed lengthy purchase lifecycles and image stability



Standard Features and Configurable Components (availability may vary by country)

OPERATING SYSTEMS

Preinstalled

Windows 8 Pro (64-bit)*

Windows 8 (64-bit)*

Windows 7 Ultimate (32-bit)**

Windows 7 Ultimate (64-bit)**

Windows 7 Professional (32-bit)**

Windows 7 Professional (64-bit)**

Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8 Pro)***

Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8 Pro)***

Windows 7 Home Premium (32-bit)**

Windows 7 Home Premium (64-bit)**

FreeDOS 2.0

Novell SUSE Linux Enterprise Desktop 11

*Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 8 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

CHIPSET

USDT SFF/TWR
Intel® Q87 Express X X

PROCESSOR

USDT SFF/TWR

Intel® 4th Generation Core™ i7 Processors

Intel® Core™ i7-4770 Processor

X

Up to 3.9 GHz Max. Turbo Frequency (3.4 GHz base frequency)

8 MB cache, 4 cores, 8 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)

Intel® Core™ i7-4770S Processor

X

Up to 3.9 GHz Max. Turbo Frequency (3.1 GHz base frequency)

8 MB cache, 4 cores, 8 threads

Intel HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)

Intel® 4th Generation Core™ i5 Processors



Standard Features and Configurable Components (availability may vary by country)

iΚ	APHICS	USDT	SFF/TWR
D	APHICS		
1	ntel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)		
Į	ntel® Core™ i5-4670S Processor Jp to 3.8 GHz Max. Turbo Frequency (3.1 GHz base frequency) 5 MB cache, 4 cores, 4 threads	x	
(((ntel® Core™ i5-4670 Processor Jp to 3.8 GHz Max. Turbo Frequency (3.4 GHz base frequency) MB cache, 4 cores, 4 threads ntel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)		X
((ntel® Core™ i5-4570S Processor Jp to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency) MB cache, 4 cores, 4 threads ntel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)	X	
(((ntel® Core™ i5-4570 Processor Up to 3.6 GHz Max. Turbo Frequency (3.2 GHz base frequency) MB cache, 4 cores, 4 threads ntel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate Supports Intel® vPro™ Technology and Intel® Stable Image Platform Program (SIPP)		X

GF

Intel HD Graphics on all models (integrated on processor)	USDT X	SFF/TWR X
mornia Grapmos on an mousic (mogration on processor)	-	^
Optional Discrete Graphics Solutions		
AMD Radeon HD 7650A (MXM)	X	
NOTE: When this MXM graphics card is installed in the USDT all three monitor ports are active. The discrete ATI graphics will operate the top DisplayPort while the Intel integrated graphics will operate the bottom Multi-Stream DisplayPort and the VGA output.		
AMD Radeon HD 8350 (1GB) PCIe x16		X
AMD Radeon HD 8490 (1GB) PCIe x 16		X
NVIDIA NVS 310 (512 MB) PCIe x16		X
NVIDIA NVS 315 (1GB) PCIe x 16		X
NVIDIA GeForce GT630 (2 GB) FH PCIe x16		TWR only
Adapters and Cables	USDT	SFF/TWR
HP DMS-59 to Dual DisplayPort Cable		X
HP DMS-59 to Dual DVI Cable		X
HP DMS-59 to Dual VGA Cable		X
HP DisplayPort to DisplayPort Cable	X	X
HP DisplayPort to DVI-D Adapter	X	X



Standard Features and Configurable Components (availability may vary by country)			
HP DisplayPort to HDMI Adapter	X	X	
HP DisplayPort to VGA Adapter	X	X	
HP Serial Port Adapter		X	
HP Parallel Port Adapter		X	

STORAGE

DIURAGE		
	USDT	SFF/TWR
SATA Hard Drive		
320 GB, 7.2K rpm, SATA 6.0 Gb/s, SMART IV, 2.5"	X	X
500 GB, 7.2K rpm, SATA 6.0 Gb/s, SMART IV, 2.5"	X	
500 GB, 7.2K rpm, SATA 6.0 Gb/s, SMART IV, 3.5"		X
500 GB, 10K rpm, SATA, 6.0 Gb/s, SMART IV, 3.5"		X
1 TB, 7.2K rpm, SATA 6.0 Gb/s, SMART IV, 3.5"		X
1 TB, 10K rpm, SATA 6.0 Gb/s, SMART IV, 3.5"		X
2 TB, 7.2K rpm, SATA 6.0 Gb/s, SMART IV, 3.5"		X
Hybrid Drives ¹		
500 GB SATA 6G 2.5 (8GB cache) SSHD Drive	X	X
500 GB SATA 6G 2.5 2nd Drive (8 GB cache) (with 3.5" adapter when install in SFF/TWR)		X
1 TB SATA 6G 2.5 (8 GB cache) SSHD Drive	X	X
1 TB SATA 6G 2.5 2nd Drive (8 GB cache) (with 3.5" adapter when install in SFF/TWR)		X
¹ Solid State Hybrid Drives are planned to be available in October 2013.		
SATA Solid State Drive		
120 GB SATA 6G 2.5 SSD	X	X
(with 3.5" adapter when installed in SFF/TWR)		
128 GB SATA 6G 2.5 SSD (with 3.5" adapter when installed in SFF/TWR)	X	X
160 GB SATA 6G 2.5 SSD	X	X
(with 3.5" adapter when installed in SFF/TWR)		
Self-encrypting Solid State Drive		
256 GB SATA 2.5" Self-Encrypting (SED) Solid State Drive	X	X
(with 3.5" adapter when installed in SFF/TWR)		
Optical Disc Drive		
Slim DVD-ROM	X	X
Slim BDXL Blu-ray Writer	X	X
Slim SuperMulti DVD Writer	X	X



Standard Features and Configurable Components (availability may vary by country)

MEMORY

Form Factor	Type	Maximum	# of Slots
Ultra Slim Desktop	DDR3 non-ECC Up to 1600 MT/s	16 GB	2 SODIMM
Small Form Factor	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM
Tower	DDR3 non-ECC Up to 1600 MT/s	32 GB	4 DIMM

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Memory modules support data transfer rates up to 1600 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

PERFORMANCE

Intel® Smart Response Technology Disk Cache Modules		SFF/TWR
32GB SATA Solid State Disk Cache		X
32GB mSATA Solid State Disk Cache	X	

NETWORKING/COMMUNICATIONS

	USDT	SFF/TWR
Ethernet (RJ-45)		
Intel I217LM Gigabit Network Connection (standard)	X	X
Intel Ethernet I210-T1 PCIe x1 Gb Network Interface Card (optional)		X
Wireless		
Intel Centrino Advanced-N 6205 802.11 a/b/g/n PCI Express x1 Network Interface Card (optional)		X
Intel Centrino Advanced-N 6205 802.11 a/b/g/n PCI Express Mini Card Wireless Network Connection (optional)	X	

NOTE: Either the integrated network connection or the Intel Centrino wireless NIC is required to support Intel vPro Technology features.



Standard Features and Configurable Components (availability may vary by country)

AUDIO/MULTIMEDIA

HD audio with Realtek ALC221 codec (all ports are stereo) DTS Studio Sound audio management technology Microphone* and headphone front ports (3.5mm)	(X
Microphone* and headphone front ports (3.5mm)		
	(X
11	(X
Line-out and Line-In rear Ports* (3.5mm)	(X
Multi-streaming capable*	(X
Internal speaker (standard)	(X

^{*} The front microphone port is re-taskable as a Line-in, Microphone-in or Headphone-out port. Rear audio input ports are re-taskable as a Line-in or Microphone-in port. External speakers must be powered externally. Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.

KEYBOARDS AND POINTING DEVICES

	USDT	SFF/TWR
Keyboard		
HP PS/2 Keyboard	X	X
HP USB Keyboard	X	X
USB Smart Card (CCID) Keyboard	X	X
HP USB and PS/2 Washable Keyboard	X	X
HP Wireless Keyboard and Mouse Combo	X	X
(Keyboard contains 25% post-consumer recycled plastic material)		
Mice		
HP PS/2 Mouse	X	X
HP USB Mouse	X	X
HP USB 1000dpi Laser Mouse	X	X
HP USB and PS/2 Washable Mouse	X	X

HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP EliteDesk 800 G1 Business PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Select models feature either Intel Standard Manageability or Intel Core vPro Processor Technology.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification 2.1
- Computrace agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (DOSFlash), BIOS updates from within Windows (HPQFlash), HP



Standard Features and Configurable Components (availability may vary by country)

Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.

HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and
 configuration management, allowing operating systems and applications to manage power based on activity
 and usage. HP Elite models use ACPI to provide power conservation features.
- S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W is S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.

SECURITY

	USDT	SFF/TWR
Trusted Platform Module (TPM) 1.2	X	X
SATA port disablement (via BIOS)	X	X
Drive lock	X	X
RAID configurations		X
Intel Identify Protection Technology (IPT) ¹	X	X
Serial, parallel, USB enable/disable (via BIOS)	X	X
Optional USB Port Disable at factory (user configurable via BIOS)	X	X
Removable media write/boot control	X	X
Power-On password (via BIOS)	X	X
Setup password (via BIOS)	X	X
HP Chassis (1 bay) Security Kit		TWR only
Solenoid Hood Lock / Sensor	X	X
Support for chassis padlocks and cable lock devices	X	X

¹Models configured with Intel Core processors have the ability to utilize advanced security protection for online transactions. IPT, used in conjunction with participating web sites, provides double identity authentication by adding a hardware component in addition to the usual user name and password. IPT is initialized through an HP Client Security module.

ENVIRONMENTAL & REGULATORY

Energy Star® qualified models available

EPEAT® registered where applicable/supported. See www.epeat.net for registration status by country.

Low halogen (chassis, all internal components and modules)

TAA compliant



Standard Features and Configurable Components (availability may vary by country)

PORTS

I/O Ports - Standard

	USDT	SFF/TWR
USB 2.0	2 (front); 4 (rear)	2 (front); 4 (rear)
USB 3.0	2 (front); 2 (rear)	2 (front); 2 (rear)
Serial (RS-232)	N/A	1
PS/2	1 keyboard (purple) 1 mouse (green)	1 keyboard (purple) 1 mouse (green)
Video	1 VGA 2 DisplayPort with multi-stream	1 VGA 2 DisplayPort with multi-stream
Audio	Front: headphone/mic Rear: line in/out 3.5mm diameter	Front: headphone/mic Rear: line in/out 3.5mm diameter
RJ-45 Network Interface	1	1

I/O Ports - Optional

	USDT	SFF/TWR
2nd Serial (RS-232)	N/A	1
Parallel	N/A	1

SLOTS

	USDT	SFF	TWR
PCI Express Mini Card	1	N/A	N/A
MXM Graphics	1	N/A	N/A
mSATA	1	N/A	N/A
PCI Express x1 (v2.0)	N/A	2 2.5" low profile 6.6" length 10W max. power	2 4.2" full height 6.6" length 10W max. power
PCI Express x16 (v2.0) (wired as a x4)	N/A	1 2.5" low profile 6.6" length 35W max. power	1 4.2" full height 6.6" length 35W max. power
PCI Express x16 (v3.0)	N/A	1 2.5" low profile 6.6" length 35W max. power	1 4.2" full height 6.6" length 75W max. power
Optional PCI (v2.3)	N/A	N/A	1 4.2" full height 6.6" length

NOTE: The TWR can support a single graphics card up to 75W. When configured with dual graphics cards support is limited to 35W for each.



Standard Features and Configurable Components (availability may vary by country)

BAYS

US	SDT SFF	TWR
3.5" Media Card Reader N	/A 1	1
5.25" Half Height ODD N	/A N/A	1
Slim ODD	1 1	1
Secure Digital (SD) Reader	1 N/A	N/A
2.5" internal storage drive	1 1	1
3.5" internal storage drive	/A 1	2

SERVICE AND SUPPORT

On-site Warranty ¹: Three-year (3-3-3) limited warranty delivers three years of on-site, next business day ² service for parts and labor and includes free telephone support ³ 24 x 7. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing a Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured and third-party HP qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.



Technical Specifications - Operating Systems, Software and eDocumentation

OPERATING SYSTEMS

Preinstalled Windows 8 Pro (64-bit)*

Windows 8 (64-bit)*

Windows 7 Ultimate (32-bit)**
Windows 7 Ultimate (64-bit)**
Windows 7 Professional (32-bit)**
Windows 7 Professional (64-bit)**

Windows 7 Professional (32-bit) (available through downgrade rights from Windows

8 Pro)***

Windows 7 Professional (64-bit) (available through downgrade rights from Windows

8 Pro)***

Windows 7 Home Premium (32-bit)**
Windows 7 Home Premium (64-bit)**

FreeDOS 2.0

Novell SUSE Linux Enterprise Desktop 11

For all Preinstalled operating systems HP provides Microsoft WHQL certified (where applicable) drivers on www.hp.com at the time of product announcement.

Web Support Windows 7 Enterprise (32-bit or 64-bit)

Windows 8 (64-bit)
Windows 8 Pro (64-bit)*
Windows 8 Enterprise (64-bit)**

For all Supported operating systems HP performs testing of the OS, and makes available all HP value add software (OS dependent). Certified drivers are made available on www.hp.com within 30 days of product announcement.

Certified Novell SUSE Linux Enterprise Desktop 11¹

Red Hat Enterprise Linux 64¹

For all Certified operating systems HP will submit hardware to the operating system vendor for testing and certification. All drivers would be obtained from the operating system vendor, not supplied by HP. Certification will be posted by the operating system vendor.

Test & Document Windows® Vista Enterprise (32-bit or 64-bit)

Windows® Vista Professional (32-bit or 64-bit)

For all Test & Document operating systems HP will perform functional testing of the operating system on the HP business PC platform. Any issues found will be documented in an Engineering Advisory and/or Service Advisory and posted to www.hp.com. HP will not develop or qualify any drivers or perform any integration testing.

*Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***This system is preinstalled with Windows® 7 Pro software and also comes with a license and media for Windows 8 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

¹The following features are not supported by Novell SUSE Linux Enterprise Desktop:

- Intel Gigabit CT Desktop NIC
- Broadcom NetXtreme Gigabit Ethernet Plus
- HP Media Card Reader
- HP Client Security
- HP Blu-ray Writer playback of commercial movies



Windows 7

QuickSpecs

Technical Specifications - Operating Systems, Software and eDocumentation

- DisplayPort video interface
- HP 2nd serial port adapter
- Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

The following features are not supported by Red Hat Enterprise Linux 64:

- TPM v1.2 embedded Security Chip
- Intel Gigabit CT Desktop NIC
- HP Wireless 802.11b/g/n NIC
- HP Media Card Reader
- HP Blu-ray Writer
- HP 2nd serial port Adapter
- HP USB Smart Card (CCID) Keyboard

Windows 8

Power Management features

Systems configured with Linux do not qualify for ENERGY STAR®

SOFTWARE

Included

inciuaea	Windows 8	windows /
Security	Computrace (status tracing) ¹ Device Access Manager Drive Encryption ⁴ File Sanitizer (Activated via Wizard) Disk Sanitizer (external version) ² Microsoft Security Essentials HP Client Security	Computrace (status tracing) ¹ Device Access Manager Drive Encryption ⁴ File Sanitizer (Activated via Wizard) Disk Sanitizer (external version) ² Microsoft Defender Secure Erase HP Client Security
MultiMedia	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)
Communication	r	HP Wireless Hotspot
HP Value Add	HP ePrint Driver ³ HP PageLift HP Support Assistant HP Recovery Disk Creator	HP ePrint Driver ³ HP PageLift HP Recovery Manager HP Support Assistant HP QuickStart
3 rd Party	Adobe Flash Player Bing Search for Internet Explorer 10 Box PDF Complete, Corporate Edition Skype	Bing Search PDF Complete, Corporate Edition Skype
Microsoft Products	Buy Office	Buy Office

¹ Computrace agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging from one to five years. Service is limited, check with Absolute for availability outside the U.S.

³ Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see



² Available via download

HP EliteDesk 800 G1 Series Business Desktop

QuickSpecs

Technical Specifications – Operating Systems, Software and eDocumentation

www.hp.com/go/eprintcenter).Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary

4 Drive Encryption is planned to be available in October 2013. Requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access.



Technical Specifications - Core vPro Processors

INTEL 4th GENERATION CORE vPRO PROCESSORS

All HP EliteDesk 800 G1 Business PC models featuring this technology include processors that are part of the Intel 2013 Stable Image Platform Program (SIPP) designed to ensure the stability promise inherent in the value proposition of the HP EliteDesk 800 G1 Business PC, thus making these models the most stable, secure, and manageable platforms available to enterprises today.

Intel Advanced Management Technology (AMT) v9.0 – An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 9.0 includes the following advanced management functions:

- Power Management (on, off, reset)
- Hardware Inventory (includes BIOS and firmware revisions
- Hardware Alerting
- Agent Presence
- System Defense Filters
- SOL/IDER
- Cisco NAC/SDN Support
- ME Wake-on-LAN
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the PC connects to the IT or service provider console for maintenance. Remote PCs can get required patches, be inventoried, etc by connecting to their IT console or Service Provider when it's convenient
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- · Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Wireless AMT functionality on Desktop (WoDT)
- Enhanced KVM resolution



Technical Specifications - Graphics

Intel HD Graphics

VGA Controller Integrated

DisplayPort Multimode capable: supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-

Stream Technology for a maximum of 3 displays (including the integrated panel)

Bus Type N/A **RAMDAC** N/A

Memory Intel graphics do not have dedicated memory but utilizes some of the computer's system memory

The amount of memory used for graphics depending on the amount of system memory installed, BIOS settings, operating system, and system load, 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP

(Protected Audio Video Playback) support for playback of protected video content.

Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

Maximum Graphics Memory

Microsoft Windows 7 Windows 8

Up to 1.7GB Up to 1.8GB

Note: the actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.

Maximum Color Depth 32 bits/pixel

Graphics/Video API Support

4th Generation Core processors:

- The Processor Graphics contains a refresh of the seventh generation graphics core enabling substantial gains in performance and lower power consumption. Up to 16 EU support.
- Next Generation Intel Clear Video Technology HD Support is a collection of video playback and enhancement features that improve the end user's viewing experience
 - Encode/transcode HD content
 - Playback of high definition content including Blu-ray Disc
 - O Superior image quality with sharper, more colorful images
- DirectX Video Acceleration (DXVA) support for accelerating video processing
 - o Full AVC/VC1/MPEG2 HW Decode
- Advanced Scheduler 2.0. 1.0
- Windows 7, Windows 8, Linux OS Support
- DirectX 11.1
- OpenGL 4.0
- Open CL 1.2

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP



Technical Specifications - Graphics

Resolution	Refresh Rates
800x600	60 Hz
1024x768	60 Hz
1152x864	60 Hz
1280x600	60 Hz
1280x720	60 Hz
1280x800	60 Hz
1280x960	60 Hz
1280x1024	60 Hz
1360x768	60 Hz
1366x768	60 Hz
1400x1050	60 Hz
1440x900	60 Hz
1600x900	60 Hz
1600x1200*	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz
1920x1200*	60 Hz
1920x1440*	60 Hz
2560x1440*	60 Hz
2560x1600*	60 Hz

^{*} Only supported on displays connected to the external DisplayPort connector.

AMD Radeon HD 7650A Graphics Card

Form Factor MXM 3.0

Graphics Controller AMD Radeon HD 7650A

Core Clock600MHzMemory Clock800MHz

Memory 2GB, DDR3, 128-bit wide

Bus TypeMXMMax. Power35W

Power Source Support 12V and 19V 3D API Support DX11, SMS

HDCP Support Yes

Display Max. Resolution Digital 2560 x 1600

Analog 2048 x 1536

Supported Graphics APIs

DX11, OpenGL, full 1080p BD (H264) playback in hardware, Multi-Stream DisplayPort

support





Technical Specifications - Graphics

Supported Display resolutions and refresh rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

Resolution	Refresh Rates
800x600	60 Hz
1024x768	60 Hz
1280x720	60 Hz
1280x1024	60 Hz
1360 x 768	60 Hz
1440x900	60 Hz
1600 x 900	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz

NVIDIA NVS 310 Graphics Card

Introduction The NVIDIA® NVS™ 310 Graphics Card is a PCI Express low profile form factor graphics

add-in card targeted as an active low cost graphics solution for the corporate business and

enterprise markets.

The NVIDIA® NVS 310 graphics card is an ideal solution for customers requiring a small form factor graphics add in earl for either standard or small form factor PC designs

form factor graphics add-in card for either standard or small form factor PC designs.

Performance and Features The NVIDIA® NVS 310 Graphics Card offers 512 MB of ultrafast DDR3 memory and is

capable of supporting up to 2 displays.

Up to 2560 x 1600 (digital display) per display

DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.

For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit

VN567AA.

Form Factor (H x L) Low Profile: 2.713×6.15 in

Graphics Controller NVIDIA® NVS 310

Memory Clock 875MHz

Memory Size 512 MB DDR3

Memory Bandwidth 14 GB/s Max. Power 19.5W

Display Max. Resolution

Display Output Up to 2 displays in the following configurations

DisplayPort output:

Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60
Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors
on the NVS 310 graphics card

• Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking

using DisplayPort Multi-Stream topology technology

DVI-D output:

- Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors
- Drives two digital display at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors



Technical Specifications - Graphics

HDMI output:

 NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors

VGA display output:

 Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors

Max. Power

19.5 W

Display Resolutions and Refresh Rates

Note: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rates (Hz) by Connection			
	DisplayPort to VGA	DisplayPort to DVI-D	DisplayPort to HDMI	DisplayPort
640 x 480	85	60	60	60
800 x 600	85	60	60	60
1024 x 768	85	60	60	60
1280 x 720	85	60	60	60
1280 x 1024	85	60	60	60
1440 x 900	75	60	60	60
1600 x 1200	60	60	60	60
1680 x 1050	60	60	60	60
1920 x 1080	60-R	60-R	60	60
1920 x 1200	60-R	60-R		60
1920 x 1440				60
2048 x 1536				60
2560 x 1600				60

Note: 60-R denotes reduced blanking timings are used on single link DVI connections and may be used with other digital connections.

NVIDIA GeForce GT630 Graphics Card

Introduction

The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Card Graphics Card provides a full height, PCI Express x16 graphics add-in card solution based on the NVIDIA Kepler Architecture GPU. The card is designed to support three display connections through its DVII, and two DisplayPort connectors.

An ideal solution for desktop PC customers seeking enhanced 2D and advanced 3D graphics performance, the NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards are an excellent choice for business users who want run multiple displays from a single graphics board. Engage in Web conferencing or video or photo editing, while improving your everyday business PC experience with better graphics and excellent visual display quality.

Performance and Features The NVIDIA GeForce GT630 DP (2GB) PCIe x16 Cards deliver superior PCI Express (PCIe) Gen 3 features including:

- Unprecedented flexibility for new applications and enhanced performance
- Support for NVIDIA surround technology
- Run multiple displays from a single graphics card
- Full 16 lane PCIe Generation 3 bus support with peak bandwidth support
- Wireless Display ready for future support

Form Factor

PCIe x16 Card

Graphics Controller

NVIDIA Kepler Architecture GPU

Core Clock Memory Clock 875 MHz

891 MHz



Technical Specifications - Graphics

Memory Size 2 GB DDR3 128 bit

Memory Bandwidth 28.5 GB/s

Display Max. Resolution 2560 x 1600 digital, 2048 x 1536 analog

Display Support Integrated 400 MHz RAMDAC

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rates (Hz)		
	Analog Connection	Digital Connection	
640x480	85	60	
800x600	85	60	
1024x768	85	60	
1280x720	85	60	
1280x1024	85	60	
1440x900	75	60	
1600x1200	85	60	
1680x1050	75	60	
1920x1080	85	60-R	
1920x1200	85	60-R	
1920x1440	85	60	
2048x1536	75	60	
2560x1600	N/A	60	

NVIDIA NVS 315 1GB PCle x 16 Graphics Card

Introduction Get efficient dual-display graphics performance in a PCI Express low-profile graphics card with

the NVIDIA NVS 315 PCIe x16 1 GB Graphics Card, an ideal desktop graphics solution for

professional business and commercial applications.

Performance and Features

The NVIDIA® NVS 315 Graphics Card offers 1 GB of ultrafast DDR3 memory and is capable of

supporting up to 2 displays.

DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and

HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.

For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.

Form Factor Low Profile: 2.713 × 6.15 in

Graphics Controller NVIDIA® NVS 315

Memory Clock875MHzMemory Size512 MB DDR3Memory Bandwidth14 GB/s

Connectors DMS-59, with support for dual VGA, dual DVI or dual Display Port with the appropriate adapter

cable

Display Max. Resolution Display Output Up to 2048 x 1536 VGA; 1920 x 1200 DVI; 2560 x 1600 DisplayPort

Up to 2 displays in the following configurations

• Dual DVI:

 Drives two DVI displays using optional HP DMS59 DVI Dual-head Connector Cable DL139A

Dual DisplayPort :

Drives two DisplayPort using optional HP DMS-59 to Dual DisplayPort kit XP688AA

Dual VGA :

O Drives two analog using the included HP DMS-59 to Dual VGA Cable





Technical Specifications - Graphics

Supported Display Resolutions and Refresh Rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

Resolution	Maximum Refresh Rates (Hz) by Connection		
	Analog Connection	Digital Connection	
640x480	85	60	
720x480	85	60	
720x576	85	60	
800x600	85	60	
1024x768	85	60	
1280x720	85	60	
1280x768	85	60	
1280x1024	85	60	
1440x900	75	60	
1600x1024	85	60	
1600x1200	85	60	
1680x1050	75	60	
1920x1080	85	60-R	
1920x1200	85	60-R	
1920x1440	85	N/A	
2048x1536	75	N/A	
2560x1440	N/A	60*	
2560x1600	N/A	60*	
		* Display Port Only	

AMD Radeon HD 8350 1GB PCie x16 DH Graphics Card

Get stable 2D and advanced 3D graphics performance from the AMD Radeon HD 8350 1 GB

Introduction PCIe x16 DH Graphics Card, a low profile, PCI Express x16 graphics add-in card based on the

AMD Radeon HD 8350 GPU, great for Web conferencing or video and photo editing.

Form Factor PCie x16

Graphics Controller AMD Radeon HD 8350

Core Clock GPU engine operates at 523 MHz

Memory 1GB, DDR3, SDRAM

Memory Clock 875 MHz
HDCP Support Yes

Display Max.Digital 1920 x 1200ResolutionAnalog 2048 x 1536

Supported Display Resolutions and Refresh Rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

	Analog Connection	Digital Connection
640x480	85	60
720x480	85	60
720x576	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x768	85	60



60

Digital Connection

QuickSpecs

Technical Specifications - Graphics

тот организация	
1280x1024	85
1440x900	75

75 1600x1024 85 60 1600x1200 85 60 1680x1050 75 75-R 1920x1080 85 60-R 1920x1200 85 60-R 85 N/A

1920x1440 85 N/A 2048x1536 75 N/A 2560x1440 N/A N/A N/A

AMD Radeon HD 8490 1GB PCie x16 Graphics Card

Get impressive graphics and high resolution dual-display performance in a low profile, PCI

Introduction Express x16 graphics add-in card based on the AMD Radeon HD 8490 Graphics Processor.

Improve your everyday PC, Web conferencing, and video or photo editing.

Form Factor PCie x16

Graphics Controller AMD Radeon HD 8490

Core Clock GPU engine operates at 875 MHz

Memory 1GB, DDR3, SDRAM

Memory Clock 900 MHz HDCP Support Yes

Display Max.Digital 2560 x 1600ResolutionAnalog 2048 x 1536

Supported Display Resolutions and Refresh Rates

NOTE: Other resolutions may be available but are not recommended as the may not have been tested and qualified by HP.

Analog Connection

	, maiog comiocitor.	Digital Commoditor
300 x 200	85	60
320 x 240	85	60
400 x 300	85	60
640x480	85	60
720x480	85	60
720x576	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x768	85	60
1280x1024	85	60
1440x900	75	75
1600 x 900	85	60
1600x1024	85	60
1600x1200	85	60
1680x1050	75	75-R
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	N/A



HP EliteDesk 800 G1 Series Business Desktop

QuickSpecs

Technical Specifications - Graphics

2048x1536	75	N/A
2560x1440	N/A	60
2560x1600	N/A	60



Technical Specifications - Hard Disk and Solid State Storage

Introduction:

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP EliteDesk 800 G1 Series Business PC supports the latest SATA 6.0Gb/s specification.

HP Drive Lock

HP Serial ATA Hard Drives offer enhanced security via a new Drive Lock. When enabled, this ATA security feature set prevents software access to user data on the drive until one or two user-defined passwords are provided.

SMART IV Technology

Self Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

Native Command Queuing

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver. AHCI support is typically implemented in RAID configurations.

Note: GB = 1 billion bytes. Actual available capacity is less.



Technical Specifications – Hard Disk and Solid State Storage

Redundant Array of Independent Drives (RAID)

Flexible implementation:

- DriveLock is supported while in RAID mode. Users can manage the DriveLock password from within F10 Setup. Locked drives will be displayed as such in the RAID option ROM interface.
- Hard drive information can be viewed within F10 Setup while in RAID mode. Previously, the hard drives will not appear in Drive Configuration when switching to RAID mode.
- DPS Self Test can be executed on physical hard drives while in RAID mode.
- The RAID Setup Utility (accessed through CTRL-I) can be protected by the F10 Setup password.

NOTE:

RAID 1 is the only RAID configuration offered via factory configurations. The pre-configured systems:

- Are only available on the SFF and TWR form factors. The USDT does not support RAID as it does not allow for more than one hard disk drive
- Are complete RAID systems and have both drives installed. If the TWR is configured with three hard disk drives, the third drive is would be un-partitioned and not part of the RAID array
- Have the necessary Option ROM configuration.
- Are pre-loaded and pre-installed with all required Intel software.
- Include a preinstalled operating system that is mirrored mode out of the box.

HP 1TB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity 1 TB

Rotational Speed 10,000 rpm

Interface Serial ATA (6.0 Gb/s) Synchronous Transfer Rate Up to 600 MB/s

(Maximum)

Buffer Size 64 MB Cache Adaptive

Single Track: 1.2 ms Seek Time (typical reads, includes controller overhead, Average: 3.6 ms including settling) Full-Stroke: 9.0 ms

Height (nominal) 0.6 in/1.53 mm

Media diameter: 2.5 in/63.6 mm Width (nominal) Physical size: 2.75 in/69.9 mm

41° to 131° F (5° to 55° C) **Operating Temperature**



Technical Specifications - Hard Disk and Solid State Storage

HP 500 GB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity 500 GB Rotational Speed 10,000 rpm

Interface Serial ATA (6.0 Gb/s)
Synchronous Transfer Rate Up to 600 MB/s

(Maximum)

Buffer Size64 MBCacheAdaptive

Seek Time (typical reads,
includes controller overhead,
including settling)Single Track:1.2 msAverage:
Full-Stroke:3.6 ms9.0 ms

Height (nominal) 0.6 in/1.53 mm

Width (nominal)

Media diameter: 2.5 in/63.6 mm
Physical size: 2.75 in/69.9 mm

Operating Temperature 41° to 131° F (5° to 55° C)

HP 320-GB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive

Capacity 320,072,933,376 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA 2.0 (6.0 Gb/s)

Buffer Size16 MBLogical Blocks488,397,168

Seek Time (typical reads,
includes controller overhead,
including settling)Single Track:
Average:2.0 ms11 ms
Full-Stroke:22 ms

Height (nominal) 0.374 in/9.5 mm

Width (nominal)

Media diameter: 2.5 in/63.5 mm
Physical size: 2.75 in/70 mm

Operating Temperature

41° to 131° F (5° to 55° C)

HP 500-GB 7200 RPM SATA 2.5" Self-Encrypting (SED) Hard Disk Drive

Capacity 500,107,862,016 bytes

Rotational Speed 7,200 rpm

Drive Type Self-Encrypting Drive (SED) with SATA interface

Interface SATA Interface conforming to Serial ATA International Organization: Serial ATA Revision 2.6

Segmented Buffer with write 32768 KB - A portion of buffer capacity used for firmware

cache

Number of Sectors 976,773,168

Seek Time (typical reads,
includes controller overhead,
including settling)Single Track:
Average:1.0 ms1.0 ms13 msFull-Stroke:25 ms

Media Diameter 2.5 in/63.5 mm

 $\begin{array}{lll} \mbox{Height} & 0.267 \ \mbox{in/6.8 mm, $\pm 0.2 mm$} \\ \mbox{Width} & 2.75 \ \mbox{in/69.85 mm, $\pm 0.25 mm$} \\ \mbox{Length} & 3.945 \ \mbox{in/100.2 mm, $\pm 0.25 mm$} \\ \end{array}$



Technical Specifications – Hard Disk and Solid State Storage

Weight 3.35 oz/95 g (max)

Operating Temperature 41° to 131° F (5° to 55° C)

HP 500-GB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive

Capacity 500,107,862,016 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA 2.0 (6.0 Gb/s)

Buffer Size16 MBLogical Blocks976,773,168

Seek Time (typical reads,
includes controller overhead,
including settling)Single Track:
Average:2.0 ms11 ms
Full-Stroke:25 ms

Height (nominal) 0.374 in/9.5 mm

Width (nominal)

Media diameter: 2.5 in/63.5 mm

Physical size: 2.75 in/70 mm

Operating Temperature 41° to 131° F (5° to 55° C)

HP 1-TB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity 1 TB

Spindle Speed 5,400 rpm +/- 0.2%

Drive Type Solid State Hybrid Drive (SSHD) technology with NAND Flash

Interface Serial ATA (SATA)

Cache Buffer64 MBNAND Flash8 GB

Commercial Multilevel Cell

(cMLC)

Number of Sectors 976,773,168

Seek Time (typical reads)

Single Track: 2.0 ms
Average: 12 ms

Height 0.374 +/-.008 in (9.5 +/- 0.2 mm)
Width 2.750 +/- 0.010 in (69.85 +/- 0.25 mm)

Length 3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)

Weight 0.254 lb/115 g (max) Operating Temperature 32° to 140° F (0° to 60° C)



Technical Specifications - Hard Disk and Solid State Storage

HP 500 GB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity 500 GB

Spindle Speed 5,400 rpm +/- 0.2%

Drive Type Solid State Hybrid Drive (SSHD) technology with NAND Flash

Interface Serial ATA (SATA)

Cache Buffer64 MBNAND Flash8 GB

Commercial Multilevel Cell

(cMLC)

Latency

Number of Sectors 976,773,168

 Seek Time (typical reads)
 Single Track: 2.0 ms

 Average: 12 ms

 Height (12 ms)

Height 0.268 +/-.008 in (6.8 +/- 0.2 mm) **Width** 2.750 +/- 0.010 in (69.85 +/- 0.25 mm)

Length 3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)

Weight 0.209 lb/95 g (max)

Operating Temperature 32° to 140° F (0° to 60° C)

HP 120-GB Solid State Drive

Unformatted Capacity 120 GB

Architecture Multi Level Cell (MLC) NAND Flash with wear leveling 10 channel controller

Interface Serial ATA 2.0 (3.0 Gb/s)

Dimensions (W x H x D) 2.74 x 0.37 x 4 in/6.98 x 0.95 x 10.2 cm

Weight 0.18 lb/80 g

Sustained Sequential Read: Up to 250 MB/s

Bandwidth Performance Sustained Sequential Write: Up to 70 MB/s

Random Read: Up to 35K IOPs
Random Write: Up to 6.6K IOPs

Read: 65-ms

Write: 85-ms

Power DC power requirement: 5 VDC 5%-100 mV ripple p-p

Total power consumption: 0.15W (active); 0.075W (idle)

Useful Drive Life 35TB written, up to 20GB/day for 5 years

Operating Temperature: 32° to 158° F (0° to 70° C)

Environmental Relative Humidity: 5% to 95% (all conditions, non- Maximum Wet Bulb

condensing)

Temperature (operating):

84° F (29° C)

Shock: 1,500 G/0.5-ms



^{*} For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

^{**} The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

Technical Specifications – Hard Disk and Solid State Storage

HP 128 GB Solid State Drive

Unformatted Capacity 128 GB*

Architecture Multi Level Cell (MLC) NAND

Interface SATA 6 GB/sec

Dimensions (W x H x D) 2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)

Weight 0.16 lb (73 g)

Sustained Sequential Read: Up to 450 MB/s

Bandwidth Performance

Sustained Sequential Write: Up to 260 MB/s
Random Read: up to 46K IOPs

Random Write: up to 56K IOPs
Read: 55ms (TYP)

Latency Write: 55ms (TYP)

DC power requirement: Min 4.5 V; Max 5.5 V

Power

Total power consumption: 160 mW (Active); <85 mW; (Idle)

Useful Drive Life 1.2 million device hours**

Operating Temperature: 32° to 158° F (0° to 70° C)

84° F (29° C)

Environmental Relative Humidity: 5% to 95% (all conditions, non-Maximum Wet Bulb

condensing) Temperature (operating):

Shock: 1,500 G/1.0 msec

Regulations UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS

CISPR 22:2002 Class B, Korea KCC, CE Mark

Option kit contents

HP 128 GB Solid State Drive, documentation, 3.5-inch bay adapter bracket,

3.5-inch bay adapter bracket screws, SATA cable

HP 160 GB Solid State Drive

Unformatted Capacity 160 GB*

Architecture Multi Level Cell (MLC) NAND

Interface SATA 3 GB/sec

Dimensions (W x H x D) 2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)

Weight 0.18 lb (80 g)

Sustained Sequential Read: Up to 250 MB/s

Bandwidth Performance Sustained Sequential Write: Up to 70 MB/s Random Read (4KB): up to 35K IOPs

Random Write (4KB): up to 6.6K IOPs

Read: 65 ms Write: 85 ms

Power DC power requirement: 5 VDC 5%-100 mV ripple p-p

Total power consumption: 0.15 Watt (Active); 0.075 Watt (Idle)

Useful Drive Life 35TB written, up to 20GB/day for 5 years **

Environmental Operating Temperature: 32° to 158° F (0° to 70° C)

(all conditions, non-Relative Humidity: 5% to 95%

condensing) Shock: 1,500 G/1.0 msec



Latency

^{*} For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

^{**} The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

Technical Specifications – Hard Disk and Solid State Storage

UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Regulations

Class B. Korea KCC. CE Mark

HP 256 GB SATA 2.5" Self-Encrypting (SED) Solid State Drive

Unformatted Capacity 256,186,209,271 bytes

Architecture Self-Encrypting (SED) Solid State Drive with 25nm MLC NAND Flash and SATA interface

Interface Serial ATA 2.0 (3.0 Gb/s) **NAND Flash** 25nm MLC NAND Flash

Height .275 in/7mm Width 2.75 in/69.85 mm 3.95 in/100.5 mm Length Weight 0.161 lb (73 g)

> Sustained Sequential 128k Read: Up to 450 MB/s

Sustained Sequential 128k Write: Up to 260 MB/s **Bandwidth Performance** Random 4k Read: up to 46K IOPs

Random 4k Write: up to 56K IOPs

Read: 55 µs Write: 55 µs

Power SATA power consumption: 160 mW (active average); <85 mW (idle average)

72TB written, up to 40GB/day for 5 years **Useful Drive Life**

> Operating Temperature: 32° to 158° F (0° to 70° C)

Environmental Relative Humidity: 5% to 95% (all conditions, non-condensing)

Shock: 1.500 G/1.0-ms

HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

500,107,862,016 bytes Capacity

Rotational Speed 7,200 rpm

Interface Serial ATA 3.0 (6.0 Gb/s)

Buffer Size 16 MB 976.773.168 **Logical Blocks**

Single Track: 2.0 ms Seek Time (typical reads, includes controller overhead, Average: 11 ms including settling) Full-Stroke: 21 ms

1 in/2.54 cm Height (nominal)

Media diameter: 3.5 in/8.89 cm Width (nominal)

Physical size: 4 in/10.2 cm

Operating Temperature 41° to 131° F (5° to 55° C)



Latency

^{*} For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

^{**} The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

Technical Specifications - Hard Disk and Solid State Storage

HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity 1,000,204,886,016 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA 3.0 (6.0 Gb/s)

Buffer Size 32 MB

Logical Blocks 1,953,525,168

Seek Time (typical reads,
includes controller overhead,
including settling)Single Track:
Average:2.0 ms11 ms
Full-Stroke:11 ms

Height (nominal) 1 in/2.54 cm

Width (nominal)

Media diameter: 3.5 in/8.89 cm
Physical size: 4 in/10.2 cm

Operating Temperature 41° to 131° F (5° to 55° C)

HP 2-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity 2 TB
Rotational Speed 7,200 rpm

Interface SATA 6Gb/s NCQ

Buffer Size 64 MB

Cache, Multisegmented

Seek Time (average)

(MB)

1,953,525,168

Read <8.5 ms
Write <9.5 ms

 Height
 1.028 in/26.11 mm

 Width
 4.0 in/101.6 mm

 Depth
 5.787 in/146.99 mm

Weight 1.38 lb/626 g

Operating Temperature 32° to 140° F (0° to 60° C)





Technical Specifications - Removable Storage

HP Slim SuperMulti DVD Writer Drive

Height 12.7mm height

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc recording capacity Up to 8.5 GB DL or 4.7 GB standard

Dimensions (W x H x D) 5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel

Weight (max) 0.42 lb (190 g)

DVD-RAM Up to 5X

DVD-R DL Up to 6X

DVD+R Up to 8X

DVD+RW Up to 8X

Write speeds DVD+R DL Up to 6X

DVD-R Up to 8X

DVD-RW Up to 6X

CD-R Up to 24X

CD-RW Up to 24X

DVD-RAM Up to 5X

DVD-RW, DVD+RW Up to 8X DVD-R DL, DVD+R DL Up to 8X

Read speeds DVD+R, DVD-R Up to 8X

DVD-ROM DL, DVD-ROM Up to 8X
CD-ROM, CD-R Up to 24X
CD-RW Up to 24X

Access time

(typical reads, including

settling)

Random
Full Stroke

DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)

DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)

Stop Time 6 seconds (typical)

Source Slimline SATA DC power receptacle

Power DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)

Temperature 41° to 122° F (5° to 50° C)

Environmental conditions

(operating - non-condensing)

Relative Humidity

10% to 80%

Maximum Wet Bulb

Temperature

84° F (29° C)

HP Slim Blu-ray BDXL Drive



Technical Specifications - Removable Storage

Height 12.7mm Slim tray-load Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc capacity Up to 128 GB QL, 100 GB TL, 50 GB DL or 25 GB standard SL

Dimensions 5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel

W x H x D (max)

Write speeds

Read speeds

Weight (max) Up to 0.37 lb (170 g) without bezel

	Triple-layer	Quadruple-layer
BD-R	Up to 4x	Up to 4x
BD-RE	Up to 2x	Not supported
	Single-layer	Double-layer
BD-R	Up to 6x	Up to 6x
BD-RE	Up to 2x	Up to 2x
DVD-R	Up to 8x	Up to 6x
DVD-RW	Up to 6x	Not supported
DVD+R	Up to 8x	Up to 6x
DVD+RW	Up to 8x	Not supported
DVD-RAM	Up to 5x	N/A
CD-R	Up to 24x	N/A
CD-RW	Up to 24x	N/A

	Triple-layer	Quadruple-layer
BD-R	Up to 4x	Up to 4x
BD-RE	Up to 4x	Not supported
	Single-layer	Double-layer
BD-ROM	Up to 6X	Up to 6X
BD-R	Up to 6x	Up to 6x
BD-RE	Up to 6x	Up to 6x
DVD-ROM	Up to 8x	Up to 8x
DVD-R	Up to 8x	Up to 8x
DVD-RW	Up to 8x	Not supported
DVD+R	Up to 8x	Up to 8X
DVD+RW	Up to 8x	Not supported

BDMV (AACS Compliant Up to 6x/2x (Read/Play)

Disc)

DVD-RAM Up to 5x

DVD-Video (CSS Up to 8x/4x (Read/Play)

Compliant Disc)

CD-R/RW/ROM Up to 24x

CD-DA (DAE) Up to 20x/10x (Read/Play)

Access times

(typical reads, including

setting)

Random BD-ROM: 205 ms (typical), DVD-ROM: 185 ms (typical),

CD-ROM: 165 ms (typical)

Full Stroke BD-ROM: 350 ms (typical), DVD-ROM: 345 ms (typical),

CD-ROM: 340 ms (typical)

Power Slimline SATA DC power receptacle Source

DC Power Requirement5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC -1200 mA typical, 2000 mA maximum



Technical Specifications - Removable Storage

Environmental Temperature (operating) 41° to 122° F (5° to 50° C)

(all conditions **Relative Humidity** 10% to 80% non-condensing)

(operating)

Maximum Wet Bulb 84° F (29° C)

Temperature (operating)

HP Slim DVD-ROM Drive

Height 12.7mm

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Dimensions (W x H x D) 5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel

Weight (max) Up to 0.37 lb (170 g) without bezel

> DVD+R/-R/+RW/ Up to 8X

-RW/+R DL /-R DL

DVD-ROM Up to 8X Read speeds

> Up to 24X CD-ROM, CD-R

CD-RW Up to 24X

Access time Random DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)

(typical reads, including

Full Stroke DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical) settling)

> Source Slimline SATA DC power receptacle

Power DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

> DC Current 5 VDC - <1000 mA typical, < 1600 mA maximum

Temperature 41° to 122° F (5° to 50° C)

Environmental (all Relative Humidity 10% to 80%

conditions non-condensing) Maximum Wet Bulb 84° F (29° C)

Temperature (operating)

Technical Specifications – Memory

System Memory Support

The HP EliteDesk 800 G1 Business PC supports the 4th generation Intel® Core™ processor family. Based on a new PC micro-architecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). Unlike previous generations, the 4th generation Intel® Core™ processor includes an Integrated Memory Controller (IMC). The IMC supports DDR3/DDR3L protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR3/DDR3L unbuffered dual in-line memory modules (UDIMM) or DDR3/DDR3L unbuffered small outline dual in-line memory modules (SO-DIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 1600 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR3/DDR3L system memory I/O voltage of 1.5V
- Theoretical maximum memory bandwidth of:
 - O 21.3 GB/s in dual-channel mode assuming 1333 MT/s
 - O 25.6 GB/s in dual-channel mode assuming 1600 MT/s

Platform Memory Support

- The Small Form Factor (SFF) and Tower (TWR) platforms support up to four (4) industry-standard DDR3-SDRAM DIMMs.
- The Ultra-slim Desktop (USDT) supports up to two (2) industry-standard DDR3-SDRAM SO-DIMMs.

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.



Technical Specifications - Networking and Communications

Intel® I217LM GbE Network Connection (integrated)

Connector RJ-45

System Interface Integrated on PCA

Controller Intel I217LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data rates supported 10/100/1000 Mbps

802.1P 802.1Q 802.2 802.3

IEEE Compliance 802.3

802.3ab 802.3az 802.3u

Bus architecture PCI Express and SMBus

Data transfer mode PCIe-based interface for active state operation (S0 state) and SMBus for host and

management traffic (Sx low power state)

Power requirement Requires 3.3V and 0.9V or just 3.3V with integrated regulators

Power consumption 0.733 Watts

Boot ROM support Yes

Network transfer mode Full-duplex

Half-duplex (not supported for the 1000BASE-T transceiver)

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps Operating Temperature: 0° to 85° C

Environmental Operating Temperature: 0° to 85° C

Operating Humidity: 60% RH

Management WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic

Alerting ASF 2.0 support; AMT 9.0 support

Intel® Ethernet I210-T1 Gigabit Network Adapter

Connector RJ-45

System Interface PCI Express x1

Controller Intel® I210 Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data rates supported 10/100/1000 Mbps

IEEE Compliance 802.1P

802.1Q 802.2 802.3 802.3AB 802.3u

802.3x flow control

Bus architecture PCI-E 2.1

Data path width X1, 250 MB/s, Bi-directional interface

Data transfer mode Bus-master DMA



Technical Specifications - Networking and Communications

Hardware certifications FCC, B, CE, TUV-c, TUVus Mark Canada and United States, TUV-GS Mark for European

Union

Power requirement Aux 3.3 V, 3.0 Watts in 1000 base-T and 1.0 Watts in 100 Base-T

Boot ROM support Yes

Network Transfer Rate

10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps

100BASE-TX (full-duplex) 200 Mbps

1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)

Environmental Operating Temperature: 32° to 131°F (0° to 55° C)

Operating Humidity: 85% at 131° F (55° C)

Management WOL, PXE, DMI, WFM 2.0

Intel Centrino Advance-N 6205 Wireless Network Interface Connection

Wireless LAN Standards IEEE 802.11a/b/g/n

IEEE 802.11 e, 802.11i, 802.11d, 802.11d, 802.11h

Interoperability Wi-Fi certified (802.11 a/b/g/n WMM, WPA, WPA2 and WPS)

Tested with wireless access points from several major manufacturers

OS compatible with Microsoft Windows, Win7 and XP

Cisco Compatible Extensions Program compliant (802.11a/b/g only) with Microsoft Windows

XP and Windows 7

Frequency Band 2.4 GHz and 5 GHz

Antenna Structure 2 transmit; 2 receive (2x2)

Data Rates 802.11b: 1, 2, 5.5, 11 Mbps

802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: 66 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined

in IEEE 802.11n specification

Modulation Direct Sequence Spread Spectrum

DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM

Security Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key

sizes of 128bits), TKIP, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP, MSCHAP,

PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, GTC Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4) with Microsoft

Windows XP only.

Sub-channels Multinational support with frequency bands and channels compliant to local regulations.

Media Access Protocol CSMA/CA (Collision Avoidance) with ACK

Network Architecture Ad-hoc (Peer to Peer)

Models

Infrastructure (Access Point Required)
Intel® My Wifi Technology (iPAN)

Roaming Provide seamless roaming between like access points (same frequency band)

Output Power (for CCK) 15 dBm Output Power (for OFDM; 15 dBm

power varies by data rate)



Technical Specifications - Networking and Communications

Power Consumption Transmit: 2.3 Watts (average, with one spatial streams)

Receive: 1.9 Watts (average with two receive chains)

Idle mode: 30mW - 40mW (average)

Radio off: 20 mW (max)

ACPI compliant power management **Power Management**

802.11 compliant power saving mode

Antenna Connections 3 U.FL type connectors, 50 ohm nominal impedance

Range 802.11 a - Typical (@6 Mbps) 600 feet - Outdoor Open Area

150 feet - Indoor, Office environment

1200 feet - Outdoor Open Area 802.11 b - Typical (@1 Mbps) 300 feet - Indoor, Office environment

1200 feet - Outdoor Open Area

300 feet - Indoor, Office environment

Form Factors USDT: MiniPCI-Express

802.11 g - Typical (@1 Mbps)

PCle CMIT & SFF:

Weight 0.013 lb (4.0 g)

Dimensions 1.1 x 1.2 in (26.8 x 30.0 mm)

Operating Voltage 3.3V +/- 9%, 1.5V +/- 5% Operating:

32° to 176° F (0° to 80° C) **Temperature** Non-operating: -40° to 176° F (-40° to 80° C)

Operating: Humidity 10% to 90% (non-condensing) Non-operating: 5% to 90% (non-condensing)

Microsoft Windows XP

Configuration Utility Microsoft Windows XP Wireless Network

Connection Manager

• Intel PROSet for Microsoft Windows XP (required for Cisco Compatible Extensions

support)

Microsoft Windows Win 7

 Intel IHV extensions for Win7 available to support Cisco Compatible Extensions



Technical Specifications - Audio

High Definition Audio

Type Integrated

HD Stereo Codec Realtek 2-channel ALC221 codec

Audio I/O Ports Front microphone-In (150-K ohm Input Impedance)

Rear Line-In/Microphone input (150-K ohm Input Impedance, function is configurable by

audio driver)

Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm load)
Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load)
Front Microphone/Headphone jack is re-task able to provide Microphone input, line-in or
Headphone output to support connecting two headphones to the front of the system. When
configured as a second front headphone output, both front headphone outputs are always

driven with the same signal.

All ports are 3.5mm

Internal Speaker Amplifier 1.5W amplifier for the internal speaker only. External speakers must be powered externally.

Rear Line-in audio port is re-taskable as either Line-in or Microphone-In.

Multi-streaming Capable Multi-streaming can be enabled in the Realtek control panel to allow independent audio

streams to be sent to/from the front and rear jacks.

Sampling 8 kHz - 192 kHz

Wavetable Syntheses Yes – Uses OS soft wavetable

Analog Audio Yes

of Channels on Line-Out Stereo (Left & Right channels)

Internal Speaker Yes
External Speaker Jack Yes
Full Duplex Yes



Technical Specifications - Input/Output Devices

HP USB Keyboard

Keys 104, 105, 106, 107, 109 layout (depending upon country)

Dimensions Physical characteristics 18.12 x 6.47 x 0.96 in (46.03 x 16.43 x 2.44 cm) $(L \times W \times H)$

> Weight 2 lb (0.9 kg) Operating voltage + 5VDC ± 5%

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector **Electrical**

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Mechanical Contamination-resistant switch membrane Switch type

> Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C) Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient) Non-operating humidity 20% to 80% (non-condensing at ambient)

Environmental Operating shock 40 g, six surfaces

> Non-operating shock 80 g, six surfaces Operating vibration 2-g peak acceleration

> Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 30 in (76.2 cm) on concrete, 16-drop sequence

Approvals UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, KC **Ergonomic compliance**

> Keyboard Installation Guide

Warranty Card Safety and Comfort Guide



Kit contents

18.22 x 6.47 x 1.1 in (46.28 x 16.43 x 2.79 cm)

QuickSpecs

Technical Specifications - Input/Output Devices

HP PS/2 Keyboard

Electrical

Keys 104, 105, 106, 107, 109 layout (depending upon country)

Physical Characteristics Dimensions (L x W x H)

Weight 2 lb (0.9 kg) minimum

Operating voltage $+ 5VDC \pm 5\%$

Power consumption 50-mA maximum (with three LEDs ON)

System interface PS/2 6-pin mini din connector

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft PC 99 - 2001 Functionally compliant

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Mechanical Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 50-dBA maximum sound pressure level

Operating temperature 32° to 104° F (0° to 40° C)

Non-operating temperature -22° to 149° F (-30° to 65° C)

Operating humidity 15% to 80% (non-condensing at ambient)
Non-operating humidity 15% to 90% (non-condensing at ambient)

Operating shock N/A

Environmental Non-operating shock 65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266

inch/second six surface

Operating vibration 2-g peak acceleration

Non-operating vibration Starting at 5 Hz, vary the frequency of vibration from 5 to

500 Hz and back to 5 Hz at a Logarithmic sweep rate of 1

octave per minute.

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 29.93 in (76 cm) on concrete, 16-drop sequence

Approvals CUL, ICES-003 Class B, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

HP USB Smart Card (CCID) Keyboard

Protects against unauthorized access with smart card technology

•



Key Benefits:

Mechanical

Environmental

Technical Specifications - Input/Output Devices

 Delivers even greater security when combined with a HP ProtectTools smart card and the HP ProtectTools Security Software

• Combination of username and password or pin with a smart card or security token

· Secures online transactions using digital signatures and certificates

Conforms to industry standards for ease of setup and use

Delivers long product life and quiet operation with high-impact materials and lubricated

keys

• Spill drain feature

Keys 104, 105, 106, 107, 109 layout

(depending upon country

Form factor USB basic smart card keyboard

Physical Characteristics Colors Carbonite/Silver

Dimensions 18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)

 $(H \times W \times D)$

Weight 2 lb (0.9 kg) minimum

Operating voltage $+ 5VDC \pm 5\%$

Power consumption 100-mA maximum (with four LEDs ON)

System interface USB Type A plug connector

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft PC 99 - 2001 Functionally compliant

Languages 30+ available
Keycaps Standard design

Switch actuation 55 g nominal peak force with tactile feedback

Switch life 20 million keystrokes

(using Hasco modified tester)

Switch type Contamination-resistant membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C) Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient) Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock 40 g, six surfaces
Non-operating shock 80 g, six surfaces
Operating vibration 2-g peak acceleration
Non-operating vibration 4-g peak acceleration

Drop 26 in (66 cm) on carpet, six-drop sequence

Drop 42 in (107 cm) on concrete, 16-drop sequence

(in box)

(out of box)

Support All ISO 7816 smart cards

Interface Reads from and writes to all ISO7816-1, 2, 3, 4 memory and

microprocessor smart cards (T=0, T=1)

Chipset SCM STCIII

Standard APIs supported PC/SC, EMV2000, CT-API

(hp

Technical Specifications - Input/Output Devices

Power **USB Port**

Short circuit detection (protects smart card and reader)

Power supply compliant with ISO7816 and EMV (5V, 60 mA)

Supports 3-V and 5-V cards

SmartCard Function Power consumption 100-mA maximum draw

> Communication From card 9600 bps to 330,000 bps

> > From computer 12 Mbps (USB transfer

> > > speed)

Friction contact Landing mechanism Contact device

> Up to 100,000 insertion cycles Card insertions rating

Interface modes CCID protocol Reader performance interface USB connection

Electro-magnetic standards Europe 2004/108/EC

> USA **USAFCC** part 15

CE-Mark, UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, EMV2000, **Approvals**

USB-IF

Ergonomic Compliance

ISO 9241-4, TUVGS

Kit Contents Keyboard, I/O Security and Documentation CD, warranty card

HP USB PS/2 Washable Keyboard

Keys 104 (US) layout or 105 (EU) layout – depending upon

country

Physical Characteristics Dimensions 17.67x 6.62 x 1.38 in (449 x 168 x 35 mm)

 $(L \times W \times H)$

Weight 1.7 lb (0.77 kg) minimum

+ 5VDC ±5% Operating voltage

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector

Electrical ESD CE level 4, 15-kV air discharge

> EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Stepped -profile design **Keycaps**

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes

Mechanical Switch type Contamination-resistant switch membrane

> Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 7 ft (2.2 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

50° to 122° F (10° to 50° C) Operating temperature



Technical Specifications - Input/Output Devices

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 95% (non-condensing at ambient)

Non-operating humidity 0% to 95% (non-condensing at ambient)

Environmental Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration

Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Operating system support Windows® 7, Windows Vista, Windows XP Professional

Approvals

UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1,

IP66/NEMA4X

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

HP Wireless Keyboard and Mouse

Dimensions (H x L x W) 1.09 x 18.1 x 6.47 in (27.87 x 460.3 x 164.3 mm)

Keyboard Weight – Without Two AA 1.94 lb (880 g)

Alkaline Batteries

Dimensions (H x L x W) 1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)

Mouse Weight – Without Two AA 0.15 lb (67 g)

Alkaline Batteries

Dimensions (H x L x W) 0.33 x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)

Weight 0.21 oz (5.9 g)

Receiver

Cable Length – Minimum 6 ft (1.8 m)
Range 32.8 ft (10 m)

Windows 7 Home Basic*, Windows 7 Home Premium*, Windows 7 Professional Edition

32*, Windows 7 Professional Edition 64*, Windows 7 Ultimate Edition 32*, Windows 7

Ultimate Edition 64* Windows Vista or Windows XP

Available USB port for the receiver

System Requirements CD-ROM Drive

*This system may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality.

See http://www.microsoft.com/windows/windows-7/ for details.

Product Safety UL; CSA /TUV (Europe only); CE Mark; CB Report Ergonomics ANSI; ISO (Europe only); GS Mark (Germany only)

EMC FCC; CE; ACA (-tick); BSMI; KC; VCCI

CE Mark EN 55022:2010; EN 55024; EN 301489-1; EN 61000

Design Guidelines for PCs PC 99 - connector overmold colors; PC 2001 - full

functionality



Technical Specifications - Input/Output Devices

Telecom All local telecom requirements and approvals for intended

markets

Approvals USA FCC Title 47 CFR, Par 15, Subpart C; other local

requirements

Country Support US, Belgium, Switzerland, Spain, Denmark, Netherlands,

France, Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia,

Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia,

Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia, Ukraine, Israel,

Croatia, United Arab Emirates, Peru, Brazil, Chile, Argentina, Mexico, South Africa, and up to 193 countries

worldwide.

Environmental Keyboard contains 25% post-consumer recycled plastic material

HP PS/2 Mouse

Dimensions (H x L x W) 1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)

Weight 3.53 oz (100g; +10g/- 5 g)

Operating temperature -32° to 104°F (0° to 40° C)

Non-operating temperature -4° to 140°F (-20° to 60° C)

Operating humidity 10% to 90%

(non condensing at ambient)

Non-operating humidity 10% to 90%

(non condensing at ambient)

Environmental Operating shock 40 g, 6 surfaces

Non-operating shock 80 g, 6 surfaces

Operating vibration 2 g peak acceleration

Non-operating vibration 4 g peak acceleration

Drop 80 cm height onto asphalt tile over concrete or equivalent,

(out of box) 5-drop in 5 direction except the cable face

Operating voltage 5 VDC ± 10%

Power consumption 100mA

System consumption PS/2 mini-din connector

ESD CE level 4, 15 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing device

Microsoft PC99 - 2001 Functionally compliant

Resolution 800 DPI

Tracking speed 10 in/s (25.4 cm/s) maximum

Acceleration ±15%

Electrical

Technical Specifications - Input/Output Devices

Switch actuation 65±20 gf

Mechanical Switch life 3,000,000 operations (using Hasco modified tester)

Switch type Low force micro-switches

Tracking mechanism life 80 km

Cable length 6 ft (1.8 m)

Microsoft PC99 - 2001 Mechanically compliant

Width 6 mm

Diameter $22.5 \pm 0.2 \text{ mm}$

Maximum rotation force 50 gf-cm Scroll wheel

Switch type Light force micro-switch

Switch life 1 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory Approvals UL/cUL, FCC, CE Mark, TUV/GS, VCCI, KCC, BSMI, C-Tick

HP USB Mouse

Dimensions (H x L x W)

1.5 x 4.5 x 2.5 in (3.8 x 11.6 x 6.3 cm)

 Weight
 0.22 lb (0.10 kg)

 Cable length
 70.9 in (180 cm)

System requirements Available USB port

HP USB 1000dpi Laser Mouse

Dimensions 1.47 x 4.53 x 2.47 in (37.3 x 114.97 x 62.86 mm)

 $(H \times L \times W)$

Weight 3.360 oz (102g)

Cable length 70.9 in (180 cm)

System requirements Available USB port

Operating Temperature 32° to 104° F (0° to 40° C)

Environmental Non-operating Temperature -4° to 140° F (-20° to 60° C)

Operating Humidity 10% to 90%

(non-condensing at ambient)

Resolution 1000dpi

Mechanical Tracking Speed 45 cm/sec

Cable Length 70.9 in (180 cm)



Technical Specifications - Input/Output Devices

HP USB PS/2 Washable Mouse

Dimensions (H x L x W) 1.56 x 2.44 x 4.61 in (3.95 x 6.21 x 11.7 cm)

Weight 4.44 oz (126 g)

Operating temperature -32° to 104°F (0° to 40° C) Non-operating -4° to 140°F (-20° to 60° C)

temperature

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 10% to 90% non-condensing

Environmental Operating shock 40 g, 6 surfaces

Non-operating shock 80 g, 6 surfaces

Operating vibration 2 g peak acceleration

Non-operating vibration 4 g peak acceleration

Drop (out of box) 80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5

direction except the cable face

Operating voltage 5 VDC ± 10%

Power consumption 100mA

System consumption PS/2 mini-din connector or USB

ESD CE level 2 8 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC99 – 2001 Functionally compliant Resolution 1000 ± 20% DPI

Tracking speed 14 in/s (35.56 cm/s) maximum

Acceleration 2 c

Switch actuation 70 g nominal peak force

Switch life 3,000,000 operations (using Hasco modified tester)

Switch type Low force micro-switches

Cable length 8.8 ft total 70 cm+ 2m extension

Microsoft PC99 - 2001 Mechanically compliant

Width 6 mm

Diameter 1 in (25.4 mm)

Scroll wheel

Maximum rotation speed 48 rats/sec

Switch type Light force micro-switch
Switch life 3 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory approvals Compliant FCC, CE Mark, ICES-003-B, IP66/NEMA4X



Technical Specifications - Power

Unit Environment and Operating Conditions

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range Operating: 50° to 95° F (10° to 35° C)*

Non-operating: -22° to 140° F(-30° to 60° C)

Relative Humidity Operating: 10% to 90% (non-condensing at ambient)

Non-operating: 5% to 95% (non-condensing at ambient)

Maximum Altitude Operating: 10,000 ft (3048 m) (unpressurized) Non-operating: 30,000 ft (9144 m)

*Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	US	SDT	SFF	TWR
Standard Efficiency	Integrated graphics:	135W active PFC 87% efficient	240W active PFC	320W active PFC
	Discrete graphics:	180W active PFC 87% efficient		
High Efficiency* 80 PLUS Gold	١	J/A	240W active PFC	320W active PFC
			87/90/87% efficient at	87/90/87% efficient at
			20/50/100% load (115V)	20/50/100% load (115V)
			89/91/90% efficient at	89/92/90% efficient at
			20/50/100% load (230V)	20/50/100% load (230V)
High Efficiency* 80 PLUS Platinum			240W active PFC	320W active PFC
			90/92/89% efficient at	90/92/89% efficient at
			20/50/100% load (115V)	20/50/100% load (115V)
			90/93/91% efficient at	90/94/91% efficient at
			20/50/100% load (230V)	20/50/100% load (230V)
Operating Voltage Range	90 - 2	64 VAC	90 - 264 VAC	90 - 264 VAC
Rated Voltage Range	100 - 2	240 VAC	100 - 240 VAC	100 - 240 VAC
Rated Line Frequency	50/6	60 Hz	50/60 Hz	50/60 Hz
Operating Line Frequency	47 -	63 Hz	47 - 63 Hz	47 - 63 Hz
Rated Input Current	N	I/A	4A	5.5A



Technical Specifications - Power

Rated Input Current with Energy Efficient* Power Supply	135W: 2.4A 180W: 2.9A	4A	5.5A
Current Leakage (NFPA 99)	< 250 μΑ	< 275 μA	<450=>275uA
Power Supply Fan	N/A	92=>70mm variable speed	92mm variable speed
Power cord length	N/A	6.0 ft. (1.83 m)	6.0 ft. (1.83 m)
Fortame at Dance at Astrontam			

External Power Adapter

Dimensions $6.7 \times 2.6 \times 1.5 \text{ in}$ N/A N/A Total Cord Length 12 ft 8 in N/A N/A



^{*}High efficiency power supply is a requirement for ENERGY STAR® qualification in conjunction with a select range of processors and modules

Technical Specifications – Weights & Dimensions

Weights &			
Dimensions (configured with 1 HDD & 1 ODD)	USDT	SFF	TWR
Chassis (W x H x D)	9.9 x 2.6 x 10 in	13.3 x 3.95 x 14.9 in	6.7 x 15.7 x 17.4 in
	251 x 66 x 254 mm	338 x 100 x 379 mm	170 x 399 x 442 mm
System Volume	257.5 cu in	782.7 cu in	1828 cu in
	4.2 L	12.8 L	30 L
System Weight*	6.8 lb	16.7 lb	20.5 lb
	3.1 kg	7.6 kg	9.3 kg
Max Supported Weight (desktop orientation)	77.0 lb 35.0 kg	77.0 lb 35.0 kg	N/A
Tower Stand	1.1 x 4.9 x 6.7 in	1.1 x 7.0 x 7.9 in	N/A
(H x W x D)	27 x 125 x 170 mm	29 x 178 x 200 mm	
Packaging	8.6 x 15.7 x 19.7 in	9.0 x 19.7 x 23.4 in	11.6 x 19.7 x 23.2 in
(H x W x D)	218 x 398 x 500 mm	229 x 500 x 594 mm	295 x 500 x 590 mm
Shipping Weight*	14.4 lb	17.9 lb	28.8 lb
	6.5 kg	8.1 kg	13.1 kg
Palletization Profile	6-units per layer	4-units per layer	4-units per layer
	10-layer max.	10-layer max.	8-layer max.
	60-units per pallet	40-units per pallet	32-units per pallet



Technical Specifications - Miscellaneous Features

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a lowpower or powered-off state without affecting other elements of the system.
- Intel Wired for Management support; industry wide initiative to make Intel architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - O Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
 - 2 processor thermal protection activated
 - 3 processor not installed
 - 4 power supply failure
 - 5 -- memory error
 - 6 video error
 - 7 PCA failure (ROM detected failure prior to video)
 - 8 invalid ROM, bootblock recovery mode
 - 9 system not fetching code
 - 10 system hang while loading an option ROM
- HP PC Hardware Diagnostics UEFI:
 - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacemen
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification



Technical Specifications – Miscellaneous Features

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Description

Towerable Orientation

Drive Protection System

Product can be oriented as either a desktop or a tower

Drive Lock

drives

Implementation of the industry standard ATA Security feature set. When enabled, it prevents software access to user data on the drive until one or two user-defined

passwords are provided.

DPS Access through F10 Setup during Boot

A diagnostic hard drive self test. It scans critical physical components and every sector of the hard drive for physical faults and then reports any faults to the user Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It

produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain

types of failures

Analysis and Reporting Technology)

SMART Technology (Self-Monitoring, Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted

SMART I - Drive Failure Prediction

Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry

SMART II - Off-Line Data Collection

By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure

SMART III - Off-Line Read Scanning with Defect Reallocation

IOEDC: I/O Error Detection Circuitry

SMART IV - End-to-End CRC for hard

Detects errors in Read/Write buffers on HDD cache RAM

Interface in F10 setup provides confirmation of SMART IV support.



Technical Specifications – Environmental Data

Environmental Data

Eco-Label
Certifications
& Declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.

*NOTE: This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.

Ultra Slim Desktop

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Ultra-slim Desktop model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Energy Consumption (in accordance with US ENERGY STAR® test method)

Normal Operation Sleep Off

115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
11.31 W	11.79 W	11.16 W
0.81 W	0.79 W	0.78 W
0.29 W	0.83 W	0.29 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*
Normal Operation
Sleen

Sleep Off

115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
39 BTU/hr	40 BTU/hr	38 BTU/hr
3 BTU/hr	3 BTU/hr	3 BTU/hr
0.9 BTU/hr	3 BTU/hr	0.9 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.



Technical Specifications - Environmental Data

Declared Noise Emissions
(in accordance with
ISO 7779 and ISO 9296)

Typically Configured - Idle Fixed Disk - Random writes

Longevity and Upgrading

3.6
3.6
This product can be upgraded, no

Sound Pressure (LpAm, decibels) 27 27

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

• 10 externally accessible USB ports

Sound Power

(LWAd, bels)

- 2 SO-DIMM memory slots
- 1 PCI Express mini card accessory slot
- 1 mSATA disc cache slot
- 1 2.5" internal storage drive bay
- 1 external slim optical drive bay

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the1ppm by weight
- Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 12.2 % post-consumer recycled plastic (by wt.)
- This product is 95.4 % recycle-able when properly disposed of at end of life.

Packaging Materials

- External:
 - o PAPER/Corrugated 1526.2 g
 - O LASTIC/Polyethylene low density 177 g
- The PAPER/Corrugated material contains at least 49.42% recycled content.
- The PLASTIC/Polyethylene low density material contains at least 60.42% recycled content.



Technical Specifications – Environmental Data

Small Form Desktop

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Small Form Factor model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Energy Consumption (in accordance with US **ENERGY STAR® test** method)

Normal Operation Sleep Off

115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
22.97 W	22.30 W	22.63 W
1.58 W	1.65 W	1.58 W
0.52 W	0.58 W	0.52 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*		
Normal Operation		
Sleep		
Off		

115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
79 BTU/hr	76 BTU/hr	77 BTU/hr
5 BTU/hr	6 BTU/hr	5 BTU/hr
2 BTU/hr	2 BTU/hr	2 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

Typically Configured - Idle

Fixed Disk - Random writes Longevity and Upgrading

Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
3.6	26
3.6	26

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 10 externally accessible USB ports
- 4 DIMM memory slots
- 2 PCI Express x16 graphics slot
- 2 PCI Express x1 accessory slots
- 1 3.5" internal storage drive bays
- 1 2.5" internal storage drive bay
- 1 3.5" Media Card Reader bay (could also support an internal storage drive)
- 1 external slim optical drive bay

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the1ppm by weight
- Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)



Technical Specifications - Environmental Data

Additional Information

Battery type: Lithium

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 14.8 % post-consumer recycled plastic (by wt.)
- This product is 94.1 % recycle-able when properly disposed of at end of life.

Packaging Materials

- External:
 - O PAPER/Corrugated 2300 g
- Internal:
 - o PLASTIC/Polyethylene low density 56 g
 - O PLASTIC/EPE-Expanded Polyethylene 110 g
 - O PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated material contains at least 38.38% recycled content.
- The PLASTIC/Polyethylene low density material contains at least 60.42% recycled content.
- The PLASTIC/EPE-Expanded Polyethylene material contains at least 60.42% recycled content
- The PLASTIC/Polyethylene material contains at least 60.42% recycled content

Tower

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Tower model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Energy Consumption (in accordance with US ENERGY STAR® test method)

Normal Operation Sleep Off

115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
24.99 W	27.67 W	25.04 W
1.55 W	1.57 W	1.54 W
0.13 W	0.60 W	0.50 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*

Normal Operation Sleep Off

115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
85 BTU/hr	95 BTU/hr	86 BTU/hr
5 BTU/hr	5 BTU/hr	5 BTU/hr
0.4 BTU/hr	2 BTU/hr	2 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.



Technical Specifications – Environmental Data

Declared Noise Emissions
(in accordance with
ISO 7779 and ISO 9296)

Typically Configured - Idle Fixed Disk - Random writes

Longevity and Upgrading

Sound Power	Sound Pressure
(LWAd, bels)	(LpAm, decibels)
3.6	25
3.6	26

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 10 externally accessible USB ports
- 4 DIMM memory slots
- 2 PCI Express x16 graphics slot
- 2 PCI Express x1 accessory slots
- 2 3.5" internal storage drive bays
- 1 2.5" internal storage drive bay
- 1 3.5" Media Card Reader bay
- 1 external slim optical drive bay
- 1 external 5.25" half height optical drive bay

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the1ppm by weight
- Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 15 % post-consumer recycled plastic (by wt.)
- This product is 95.5 % recycle-able when properly disposed of at end of life.

Packaging Materials

- External:
 - PAPER/Corrugated 2280 g
- Internal:
 - PLASTIC/Polyethylene low density 40 g
 - O PLASTIC/EPE-Expanded Polyethylene 144 g
 - O PLASTIC/Polypropylene 15 g
- The PAPER/Corrugated packaging material contains at least 53.5 % recycled content.
- The PLASTIC/Polyethylene low density packaging material contains at least 60.42 % recycled content
- The PLASTIC/EPE-Expanded Polyethylene packaging material contains at least 60.42 % recycled content.
- The PLASTIC/Polypropylene packaging material contains at least 60.42 % recycled



Technical Specifications – Environmental Data

content.

Common to all Form Factors

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- · Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

Recycling

End-of-life Management and Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuserecycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

> The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Environmental Information

Hewlett-Packard Corporate For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications



HP EliteDesk 800 G1 Series Business Desktop

QuickSpecs

Technical Specifications - Environmental Data

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certificate.pdf

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



After-Market Options (availability may vary by region)

Communication Devices	USDT	SFF/TWR	Part Number
Intel Ethernet I210 - T1 Gbe NIC		Χ	E0X95AA
Intel 6205 802.11 a/b/g/n PCIe x1 NIC		Χ	E0X93AA
Note: The use of any of these optional NIC Cards (wired or wireless)	will disable the	Intel vPro Techn	ology features.

Graphics Solutions	USDT	SFF/TWR	Part Number
AMD Radeon HD 8350 Graphics (PCIe x16)		Χ	E1C63AA
AMD Radeon HD 8490 Graphics Card		Χ	E1C64AA
Nvidia NVS 310 Graphics (PCIe x16)		Χ	A7U59AA
Nvidia NVS 315 Graphics (PCIe x16)		Χ	E1C65AA
HP DisplayPort Cable Kit	X	Χ	VN567AA
HP DisplayPort To Dual Link DVI-D Adapter	X	Χ	NR078AA
HP DisplayPort To DVI-D Adapter	X	Χ	FH973AA
HP DisplayPort to HDMI Adapter	X	Χ	BP937AA
HP DisplayPort to VGA Adapter	X	Χ	AS615AA
HP DMS-59 to Dual DVI Cable		Χ	DL139A
HP DMS-59 to Dual DisplayPort Adapter		Χ	XP688AA

Data Storage Drives and Accessories	USDT	SFF/TWR	Part Number
HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		Χ	QK554AA
HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		X	QK555AA
HP 1-TB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive		Χ	C2T91AA
HP 128-GB SATA 3.0Gb/s Solid State Drive	Χ	X	QV063AA
HP 160-GB SATA 3.0Gb/s Solid State Drive	Χ	X	QV064AA*
HP 500-GB SATA 3.0Gb/s Solid State Hybrid Drive	Χ	Χ	E1C62AA
HP Slim Removable SATA Hard Drive Enclosure (frame & carrier)	Χ	Χ	C1N41AA
HP Slim Removable SATA Hard Drive Enclosure (carrier only)	Χ	Χ	E3F39AA
HP Chassis (1bay) Security Kit		TWR only	AR639AA
White the condition of			

^{*}Not available in all regions.

Input Devices	USDT	SFF/TWR	Part Number
HP USB Keyboard	Χ	X	QY776AA
HP USB Gray Keyboard	Χ	Χ	B6B64AA
HP USB Smart Card (CCID) Keyboard	Χ	Χ	BV813AA
HP USB Keyboard and Mouse Kit	Χ	Χ	B1T09AA
HP USB Washable Keyboard	Χ	Χ	VF097AA
HP USB and PS/2 Washable Mouse	Χ	Χ	BM866AA
HP USB and PS/2 Washable Keyboard and Mouse Kit	Χ	Χ	BU207AA
HP PS/2 Mouse	Χ	Χ	QY775AA
HP USB Mouse	Χ	Χ	QY777AA
HP USB 1000dpi Laser Mouse	Χ	Χ	QY778AA
HP Wireless Keyboard and Mouse Combination (Keyboard contains 25% post-consumer recycled plastic material)	Х	Χ	QY449AA



After-Market Options (availability may vary by region)

-			
System Memory	USDT	SFF/TWR	Part Number
HP 4GB DDR3-1600 (PC3-12800) DIMM		Χ	B4U36AA
HP 8GB DDR3-1600 (PC3-12800) DIMM		Χ	BU37AA
HP 4GB DDR3-1600 (PC3-12800) SODIMM	Χ		B4U39AA
HP 8GB DDR3-1600 (PC3-12800) SODIMM	Χ		B4U40AA
Multimedia Devices	USDT	SFF/TWR	Part Number
HP Slim DVD-ROM Drive	Χ	Χ	VP033AA
HP Slim SuperMulti DVD Writer Drive	Χ	Χ	QS209AA
HP USB HD 720P v2 Business Webcam	Χ	Χ	D8Z08AA
HP Business Headset	Х	Х	QK550AA
Removable Media Storage	USDT	SFF/TWR	Part Number
HP 14-n-1 Media Card Reader (available Dec. 2013)		X	TBD
Security Devices	USDT	SFF/TWR	Part Number
HP USDT Rear Port Controller Cover	Χ		VN571AA
HP Solenoid Lock and Hood Sensor (USDT/SFF)		SFF only	E0X97AA
HP Solenoid Lock and Hood Sensor (TWR)		TWR only	E0X96AA
HP SFF Wall Mount/Security Sleeve		SFF only	VN570AA
HP UltraSlim Cable Lock	X	X	H4D73AA
Stands and Accessories	USDT	SFF/TWR	Part Number
HP Integrated Work Center Stand (SFF)		SFF only	QP897AA
HP Integrated Work Center Stand (USDT)	Χ	_	LH526AA
HP USDT Tower Stand	Χ		VN568AA
HP SFF Tower Stand		SFF only	VN569AA
HP 600/800 Tower Bezel Kit		TWR only	E1C66AA
HP 800/600 SFF Bezel Kit		SFF only	E3F27AA
HP 800 USDT Kit	Χ	-	E3F28AA
HP Serial Port Adapter (RS-232 compatible)		Χ	PA716A
HP Parallel Port Kit		Χ	KD061AA
HP PCI Expansion Kit		TWR only	E1V16AA



After-Market Options (availability may vary by region)

LANDesk Software (E-Delivery)	Part Number
LANDesk Management Suite License - 1-499 Nodes E-Delivery	QY369AAE
LANDesk Management Suite License - 500-999 Nodes E-Delivery	QY370AAE
LANDesk Management Suite License - 1000-1999 Nodes E-Delivery	QY371AAE
LANDesk Management Suite License - 2000-4999 Nodes E-Delivery	QY372AAE
LANDesk Management Suite License - 5000-9999 Nodes E-Delivery	QY373AAE
LANDesk Security Suite License E-Delivery	QY379AAE
LANDesk Management Suite 1 Year Maintenance - 1-499 Nodes E-Delivery	HZ825AAE
LANDesk Management Suite 1 Year Maintenance - 500-999 Nodes E-Delivery	HZ826AAE
LANDesk Management Suite 1 Year Maintenance - 1000-1999 Nodes E-Delivery	HZ827AAE
LANDesk Management Suite 1 Year Maintenance - 2000-4999 Nodes E-Delivery	HZ828AAE
LANDesk Management Suite 1 Year Maintenance - 5000-9999 Nodes E-Delivery	HZ829AAE
LANDesk Security Suite 1 Year Subscription	HZ830AAE
LANDesk Patch Management 1 Year Subscription - 1-499 Nodes E-Delivery	HZ831AAE
LANDesk Patch Management 1 Year Subscription - 500-999 Nodes E-Delivery	HZ832AAE
LANDesk Patch Management 1 Year Subscription - 1000-1999 Nodes E-Delivery	HZ833AAE
LANDesk Patch Management 1 Year Subscription - 2000-4999 Nodes E-Delivery	HZ834AAE
LANDesk Patch Management 1 Year Subscription - 5000-9999 Nodes E-Delivery	HZ835AAE

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